



Title of Change:	Change of reel quantity from 3000/reel to 5000/reel for NCP153MX330180TCG.	
Effective date:	6 July 2018	
Contact information:	Contact your local ON Semiconductor Sales Office or <Peter.kim@onsemi.com>	
Type of notification:	This Product Bulletin is for notification purposes only. ON Semiconductor will proceed with implementation of this change upon publication of this Product Bulletin.	
Change Category:	<input type="checkbox"/> Wafer Fab <input type="checkbox"/> Assembly Change <input type="checkbox"/> Test Change <input checked="" type="checkbox"/> Other <u>Reel Packing Quantity</u>	
Change Sub-Category(s):	<input type="checkbox"/> Manufacturing Site Addition <input type="checkbox"/> Material Change <input type="checkbox"/> Datasheet/Product Doc change <input type="checkbox"/> Manufacturing Site Transfer <input type="checkbox"/> Product specific change <input checked="" type="checkbox"/> Shipping/Packaging/Marking <input type="checkbox"/> Manufacturing Process Change <input type="checkbox"/> Other: _____	
Sites Affected:	ON Semiconductor Sites: ON Tarlac City, Philippines	External Foundry/Subcon Sites: Stars Microelectronics, Thailand
Description and Purpose:		
The full reel quantity of NCP153MX330180TCG will be increased from 3000/reel to 5000/reel in order to allow customers to improve manufacturing efficiencies by reducing the reel change frequency. There is no change to form/fit/function of the manufactured product, or to the reel packing/packaging materials. The product datasheet has been updated to reflect the quantity/reel change. Minimum order quantities have also been updated accordingly. Product assembled and packaged prior to the cutover date will be ordered and shipped in the original 3000/reel quantities.		
List of Affected Part:		
NCP153MX330180TCG		



Appendix A: Changed Products

Product	Customer Part Number
NCP153MX330180TCG	